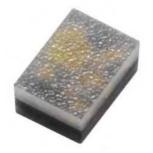


DATASHEET

SMD EAST1410RGBW02



Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow.
- Solder process.
- Full-color type.
- Pb-free.
- Component solderable surface finish is Gold.
- Component weight is 1.5 mg.
- The Product itself will remain within RoHS compliant version.
- Compliance with EU REACH.
- Compliance Halogen Free.(Br<900ppm,Cl<900ppm,B+Cl<1500ppm).

Description

- The EAST1410RGBW02 SMD LED is much smaller than lead frame type components, thus enables smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Moreover, with its black PCB, the EAST1410RGBW02 possess an ideal solution for high-contract and high-resolution indoor signage display.

Applications

- Indoor signage display applications.
- Indoor decorating and entertainment design.
- Flat backlight for LCD, switch and symbol.
- Indicator and backlighting for all consumer electronics.

Device Selection Guide

Chip Materials	Emitted Color	Resin Color
AlGaInP	Brilliant Red	
InGaN	Brilliant Green	 White Surface Diffused
InGaN	Brilliant Blue	
InGaN	Brilliant White	

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit		
Forward Current	lf	R6:10 GA:10 BD:10 T8: 10	mA		
Peak Forward Current (Duty 1/10 @1KHz)	IFP	R6:15 GA:15 BD:15 T8: 15	mA		
Power Dissipation	Pd	R6:19 GA:29 BD:29 T8:29	mW		
Junction Temperature	Tj	100	°C		
Operating Temperature	T _{opr}	-40 ~ +85	°C		
Storage Temperature	Tstg	-40 ~ +90	°C		
ESD (Classification acc. AEC Q101)	ESDнвм	R:2000 G:150 B:150 W:150	V		
Soldering Temperature	T _{sol}		Reflow Soldering : 260 $^{\circ}$ C for 10 sec. Hand Soldering : 350 $^{\circ}$ C for 3 sec.		

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbo	1 1	Min.	Тур.	Max.	Unit	Condition
		R6	3		8.5		
Luminous Intensity	lv	GA	25		63	mcd	l⊧=1mA
Eurimous intensity		BD	5		16	mcu	IF= 11174
		T8	10		30		
Viewing Angle	20 1/2			120		deg	I⊧=1mA
		R6	616		628		
Dominant Wavelength	Λd	GA	523		538		L- 1m A
Color Temp.		BD	463		478	nm	l⊧=1mA
	СТ	Т8	5000		8000	К	
		R6	1.6		1.9		
Forward Voltage	VF	GA	2.3		2.5	V	l⊧=1mA
		BD	2.6		2.8	v	IF= 1117
		Т8	2.6		2.8		
Reverse Current ⁴	IR				10	nA	V _R =9V

Note:

- 1. Tolerance of Luminous Intensity: ±10%
- 2. Tolerance of Dominant Wavelength: ±1nm
- 3. Tolerance of Forward Voltage: ±0.1V
- 4. Only for Electronic test

Floating Bin(R6) Bin Range of Luminous Intensity

Bin Code	Min.	Max.	Unit	Condition
RA	3.0	5.0	– mcd	
RB	5.0	8.5		l⊧ =1mA

Bin Range of Dominant Wavelength

Bin Code	Min.	Max.	Unit	Condition
R1	616	628	nm	I⊧ =1mA

Bin Range of Dominant Voltage

Bin Code	Min.	Max.	Unit	Condition
R1	1.6	1.9	V	I _F =1mA

Note:

1.Tolerance of Luminous Intensity: ±10%

2.Tolerance of Dominant Wavelength: ±1nm

3. Tolerance of Forward Voltage: ±0.1V

Floating Bin(GA) Bin Range of Luminous Intensity

Bin Code	Min.	Max.	Unit	Condition
GA	25.0	40.0		I1mA
GB	40.0	64.0	- mcd	l _F =1mA

Bin Range of Dominant Wavelength

``Bin Code	Min.	Max.	Unit	Condition
G1	523	538	nm	I _F =1mA

Bin Range of Dominant Voltage

Bin Code	Min.	Max.	Unit	Condition
G1	2.3	2.5	V	I⊧ =1mA

Note:

1.Tolerance of Luminous Intensity: ±10%

2. Tolerance of Dominant Wavelength: ±1nm

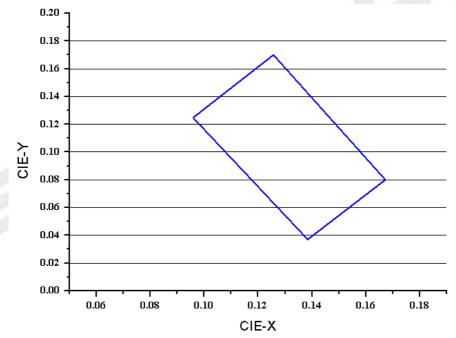
3. Tolerance of Forward Voltage: ±0.1V

Floating Bin(BD) Bin Range of Luminous Intensity

Bin Code	Min.	Max.	Unit	Condition
BA	5.0	9.0	mad	Ι <u></u> 1 m Λ
BB	9.0	16.0	– mcd	l⊧ =1mA

Bin Range of CIE

Bin Code	x	Y.	Condition
	0.1384	0.0370	
B1	0.0959	0.1248	I _F =1mA
	0.1257	0.1700	
	0.1672	0.0800	



Bin Range of Dominant Voltage

Bin Code	Min.	Max.	Unit	Condition
B1	2.6	2.8	V	I _F =1mA

Note:

- 1.Tolerance of Luminous Intensity: ±10%
- 2. Tolerance of Color coordinates: ±0.01
- 3. Tolerance of Forward Voltage: ±0.1V

Floating Bin(T8) **Bin Range of Luminous Intensity**

Bin Code	Min.	Max.	Unit	Condition
ТА	10.0	17.0		L_ 1 m A
ТВ	17.0	30.0	- mcd	l⊧ =1mA

Bin Range of Dominant Voltage

Bin Code	Min.	Max.	Unit	Condition
T1	2.6	2.8	V	l⊧ =1mA

Note:

1.Tolerance of Luminous Intensity: ±10%

2. Tolerance of Forward Voltage: ±0.1V

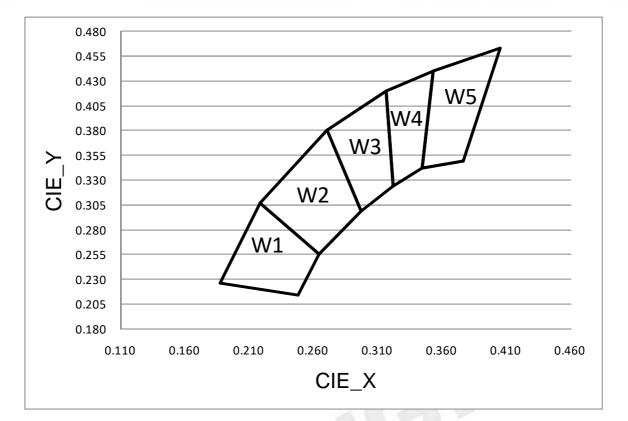
Bin Range of CIE

Bin Code	Х	Y.	Condition
W1	0.264	0.256	
	0.218	0.307	_
	0.187	0.226	
	0.248	0.214	
W2	0.297	0.299	
	0.270	0.380	
	0.218	0.307	_
	0.264	0.256	
W3	0.297	0.299	
	0.270	0.380	I _F =1mA
	0.316	0.420	
	0.322	0.324	
W4 —	0.322	0.324	
	0.316	0.420	
	0.353	0.440	
	0.344	0.342	
W5	0.377	0.349	
	0.405	0.463	
	0.353	0.440	-
	0.344	0.342	

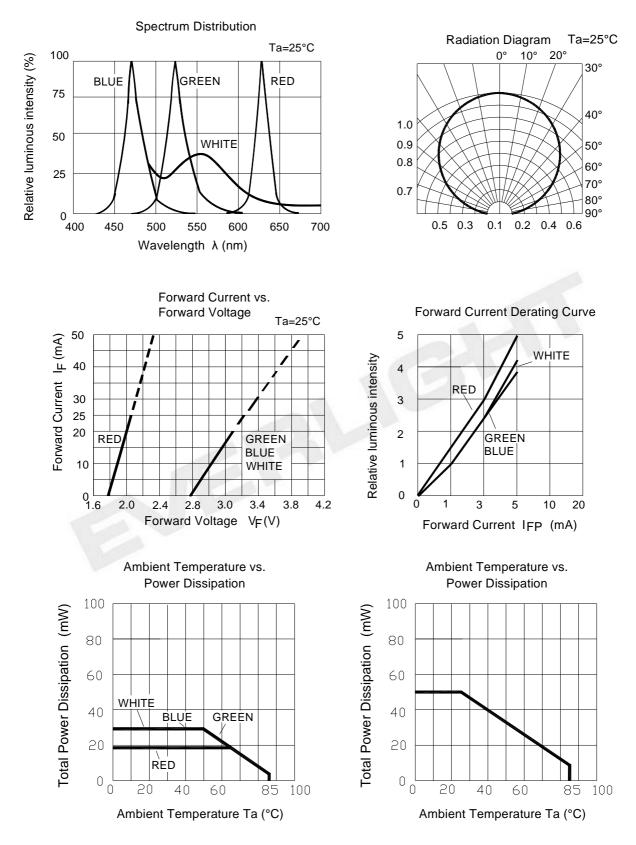
Note:

1. Tolerance of Color coordinates: ±0.01

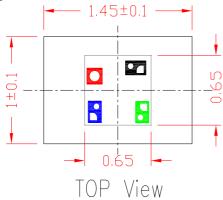


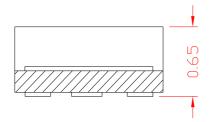


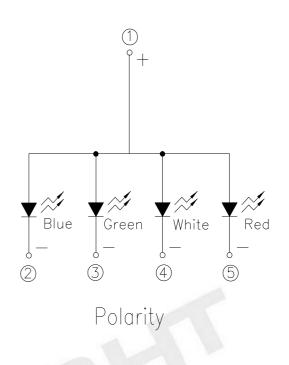
Typical Electro-Optical Characteristics Curves



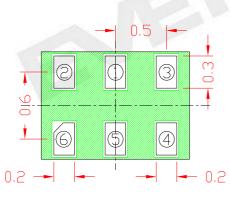




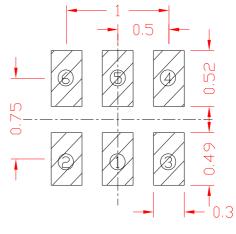




Recommend Soldering Pad







單位:mm 公差:±0.05

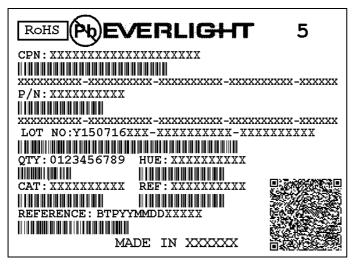
Suggested pad dimension is just for reference only. Please modify the pad dimension based on individual need.

Note: Tolerances unless mentioned ± 0.1 mm. Unit = mm PAD 6 is only for soldering use, not for electrical use.



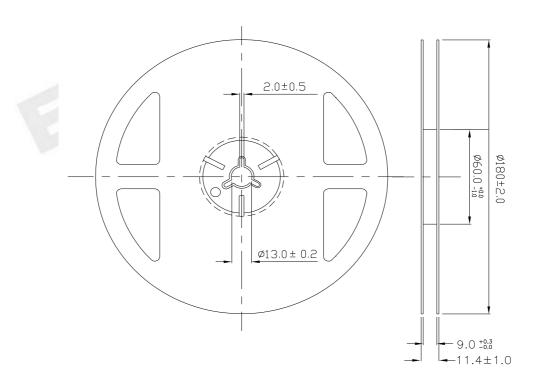
Moisture Resistant Packing Materials

Label Explanation

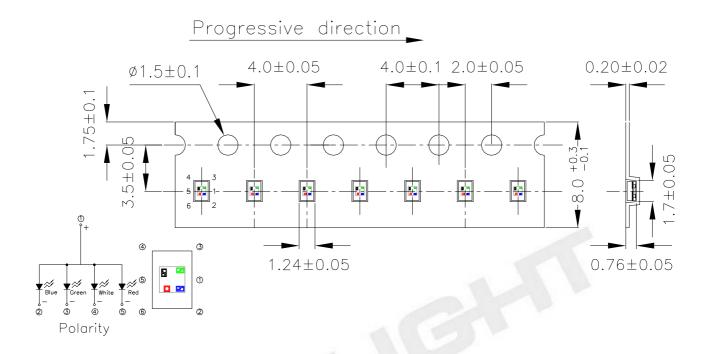


- CPN: Customer's Product Number
- P/N: Product Number
- QTY: Packing Quantity
- CAT: Luminous Intensity Rank
- HUE: Dom. Wavelength Rank
- REF: Forward Voltage Rank
- LOT No: Lot Number

Reel Dimensions

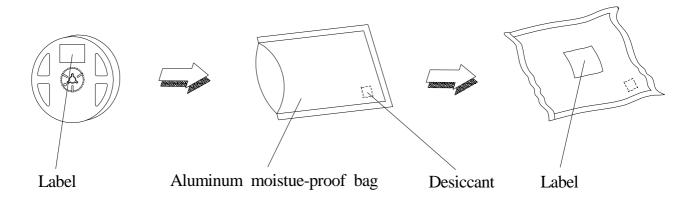


Carrier Tape Dimensions: Minimum packing amount is 4000 pcs per reel



Note: Tolerances unless mentioned ±0.1mm. Unit = mm

Moisture Resistant Packing Process



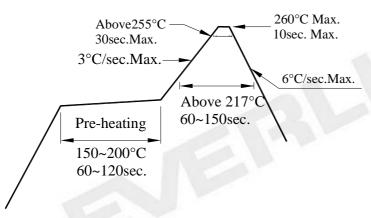
Note: Tolerances unless mentioned ±0.1mm. Unit = mm

Precautions for Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big cur change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or les
 - 2.3 After opening the package: The LED's floor life is 168Hrs under 30°C or less and 60% RH less. If unused LEDs remain, it should be stored in moisture proof packages.
 - 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded storage time, baking treatment should be performed using the following conditions. Baking treatment : 60±5°C for 24 hours.
- 3. Soldering Condition
 - 3.1 Pb-free solder temperature profile



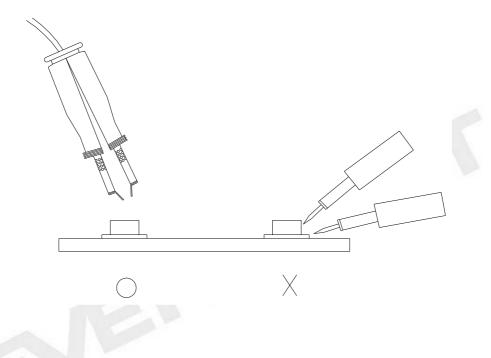
- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



6.Directions for use

The LEDs should be operated with forward bias. The driving circuit must be designed so that the LEDs are not subjected to forward or reverse voltage while it is off. If reverse voltage is continuously applied to the LEDs, It may cause migration resulting in LED damage.

DISCLAIMER

- 1. EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
- 2. The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
- 3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
- 4. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
- 5. These specification sheets include materials protected under copyright of EVERLIGHT. Reproduction in any form is prohibited without obtaining EVERLIGHT's prior consent.
- 6. This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or life saving applications or any other application which can result in human injury or death. Please contact authorized Everlight sales agent for special application request.